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17. [Deletion] A semiconductor device, comprising
a transparent substrate with first texture on one of its two surfaces and second texture on
other surface,
a first epitaxial layer comprising first active layer and grown on the top of said first
texture,
a second epitaxial layer comprising second active layer and grown on the top of said
second texture.
18. [Deletion] The semiconductor device of claim 17, further comprising first buffer layer
grown in between said first epitaxial layer and said first texture
of said substrate, and a second buffer layer grown in between said
second epitaxial layer and said second texture of said substrate.
19. [Deletion] The semiconductor device of claim 17, wherein both said first texture and said
second texture comprising wells and walls.
20. [Deletion] The semiconductor device of claim 19, wherein the width of said wells is in a
range of nanometers to micrometers.
21. [Deletion] The semiconductor device of claim 19, wherein the depth of said wells is in a
range of nanometers to micrometers.
22. [Deletion] The semiconductor device of claim 19, wherein said wells have the shape of
said semiconductor device.
23. [Deletion] The semiconductor device of claim 19, wherein the thickness of said wells is
in the range of nanometers to micrometers.

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Page 2 of the OA
Quote of the OA:

"...Accordingly, the identified species 1-6 are indeed perceivable distinctive from each other. Therefore, to respond to this Office action, applicant is required to select a single species among the identified species 1-6, and identify the claims readable on the elected single species."

Response:

Applicant respectfully elects specie 1, and identifies the claims 1-8 readable on the elected specie.

Page 3 of the OA
Quote of the OA:

"The amendment to the claims filed on 3/18/2005 does not comply with the requirement of 37CFR 1.21(c) because the amendment lacks a marked version so as to show what are the changes made to the claims. Addition should be underlined, and deletion should be bracketed (with [])."

Response:

Applicant respectfully marks the deletions, and there is no addition.

CONCLUSION

For all the above reasons, applicant submit that the specification and claims are now in proper form, and that the claims all define patentable over the prior art. Therefore applicant submit that this application is now in condition for allowance, which action they respectfully solicit.

Conditional Request for Constructive Assistance

Applicants have amended the specification and claims of this application so that they are proper, definite, and define novel structure, which is also unobvious. If, for any reason this application is not believed to be in full condition for allowance, applicants respectfully request the constructive assistance and suggestions of the Examiner pursuant to M.P.B.P. Section 2172.02 and section 2173.07(j) in order that the undersigned can place this application in allowable condition as soon as possible and without the need of further proceedings.

Very respectfully,

Rui Feng


Applicants for use

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Certificate of Mailing: I certify that, on the date below, this correspondence will be deposited with the United States Postal Service by First Class Mail, postage prepaid, in an envelope addressed to: "Box, Non-Fee Amendments, Commissioner for Patents, P. O. Box 450, Alexandria, VA 22315-0450", and faxed to 703-572-5306.

Date: June 27, 2005

Inventor's signature:

